# 4V Drive Pch+Pch MOSFET

## SH8J62

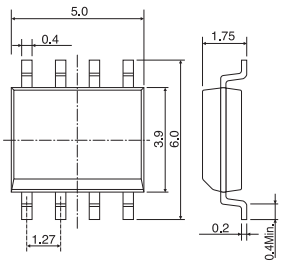
### ●Structure
Silicon P-channel MOSFET

### ●Features
1) Low On-resistance.
2) Built-in G-S Protection Diode.
3) Small Surface Mount Package (SOP8).

### ●Application
Switching

### ●Dimensions (Unit : mm)

SOP8

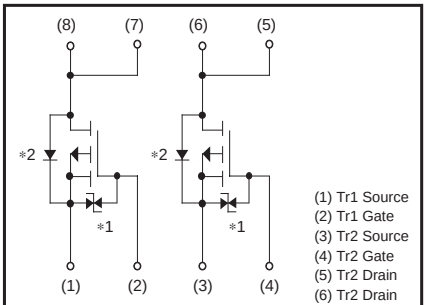



Each lead has same dimensions

### ●Packaging specifications

| | | |
|---|---|---|
| Type | Package | Taping |
| | Code | TB |
| | Basic ordering unit (pieces) | 2500 |
| SH8J62 | | ◯ |

### ●Inner circuit




∗1 ESD PROTECTION DIODE
∗2 BODY DIODE

### ●Absolute maximum ratings (Ta=25°C)
<It is the same ratings for the Tr1 and Tr2.>

| Parameter | | Symbol | Limits | Unit |
|---|---|---|---|---|
| Drain-source voltage | | $V_{DSS}$ | −30 | V |
| Gate-source voltage | | $V_{GSS}$ | ±20 | V |
| Drain current | Continuous | $I_D$ | ±4.5 | A |
| | Pulsed | $I_{DP}$ ∗1 | ±18 | A |
| Source current (Body diode) | Continuous | $I_S$ | −1.6 | A |
| | Pulsed | $I_{SP}$ ∗1 | −18 | A |
| Total power dissipation | | $P_D$ ∗2 | 2.0 | W / TOTAL |
| | | | 1.4 | W / ELEMENT |
| Channel temperature | | Tch | 150 | °C |
| Range of Storage temperature | | Tstg | −55 to +150 | °C |

∗1 Pw≤10μs, Duty cycle≤1%
∗2 Mounted on a ceramic board

●**Electrical characteristics** (Ta=25°C)
<It is the same characteristics for the Tr1 and Tr2.>

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|---|---|---|---|---|---|---|
| Gate-source leakage | $I_{GSS}$ | – | – | ±10 | μA | $V_{GS}$=±20V, $V_{DS}$=0V |
| Drain-source breakdown voltage | $V_{(BR)\ DSS}$ | –30 | – | – | V | $I_D$= –1mA, $V_{GS}$=0V |
| Zero gate voltage drain current | $I_{DSS}$ | – | – | –1 | μA | $V_{DS}$= –30V, $V_{GS}$=0V |
| Gate threshold voltage | $V_{GS\ (th)}$ | –1.0 | – | –2.5 | V | $V_{DS}$= –10V, $I_D$= –1mA |
| Static drain-source on-state resistance | $R_{DS\ (on)}$ * | – | 40 | 56 | mΩ | $I_D$= –4.5A, $V_{GS}$= –10V |
| | | – | 55 | 77 | mΩ | $I_D$= –2.5A, $V_{GS}$= –4.5V |
| | | – | 60 | 84 | mΩ | $I_D$= –2.5A, $V_{GS}$= –4.0V |
| Forward transfer admittance | $\|Y_{fs}\|$ * | 3.5 | – | – | S | $V_{DS}$= –10V, $I_D$= –4.5A |
| Input capacitance | $C_{iss}$ | – | 800 | – | pF | $V_{DS}$= –10V |
| Output capacitance | $C_{oss}$ | – | 120 | – | pF | $V_{GS}$=0V |
| Reverse transfer capacitance | $C_{rss}$ | – | 110 | – | pF | f=1MHz |
| Turn-on delay time | $t_{d\ (on)}$ * | – | 7 | – | ns | $I_D$= –2.5A<br>$V_{DD}$≒ –15V<br>$V_{GS}$= –10V<br>$R_L$=6.0Ω<br>$R_G$=10Ω |
| Rise time | $t_r$ * | – | 15 | – | ns | |
| Turn-off delay time | $t_{d\ (off)}$ * | – | 70 | – | ns | |
| Fall time | $t_f$ * | – | 50 | – | ns | |
| Total gate charge | $Q_g$ * | – | 8.0 | – | nC | $V_{DD}$≒ –15V<br>$I_D$= –4.5A<br>$V_{GS}$= –5V<br>$R_L$=3.3Ω / $R_G$=10Ω |
| Gate-source charge | $Q_{gs}$ * | – | 2.5 | – | nC | |
| Gate-drain charge | $Q_{gd}$ * | – | 3.0 | – | nC | |

*Pulsed

●**Body diode characteristics** (Source-Drain) (Ta=25°C)
<It is the same characteristics for the Tr1 and Tr2.>

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|---|---|---|---|---|---|---|
| Forward voltage | $V_{SD}$ * | – | – | –1.2 | V | $I_S$= –4.5A, $V_{GS}$=0V |

* Pulsed

## ●Electrical characteristic curves

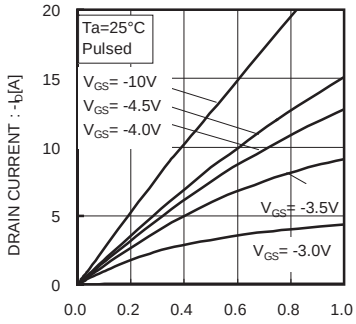



Fig.1 Typical output characteristics(Ⅰ)

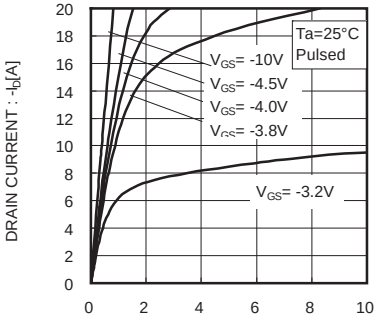



Fig.2 Typical output characteristics(Ⅱ)

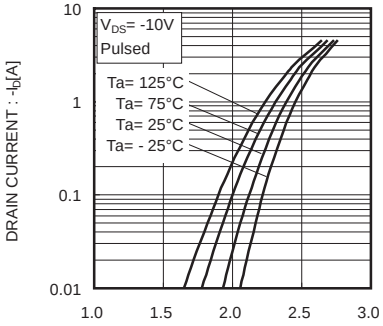



Fig.3 Typical Transfer Characteristics

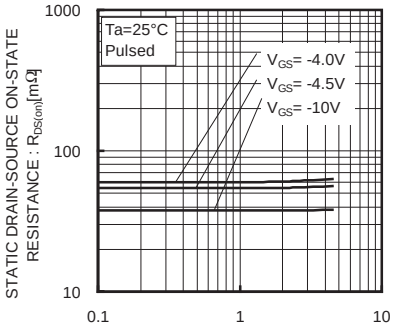



Fig.4 Static Drain-Source On-State Resistance vs. Drain Current(Ⅰ)

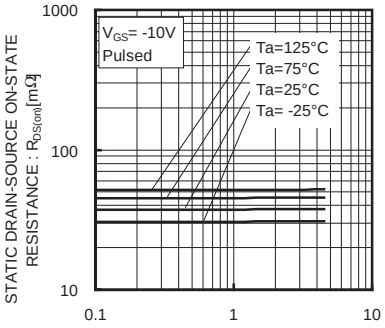



Fig.5 Static Drain-Source On-State Resistance vs. Drain Current(Ⅱ)

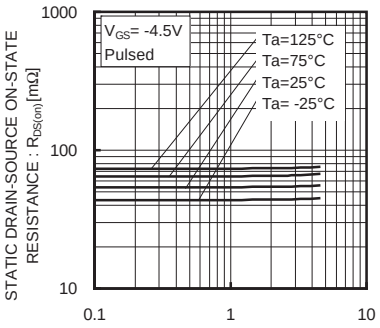



Fig.6 Static Drain-Source On-State Resistance vs. Drain Current(Ⅲ)

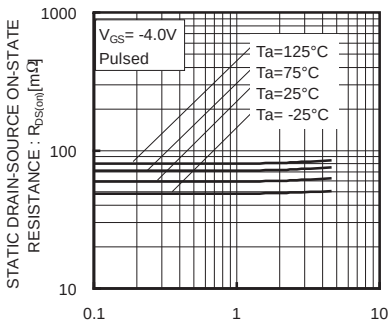



Fig.7 Static Drain-Source On-State Resistance vs. Drain Current(Ⅳ)

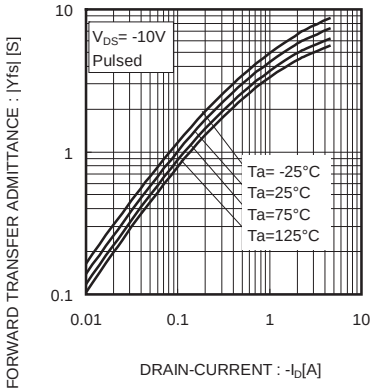



Fig.8 Forward Transfer Admittance vs. Drain Current

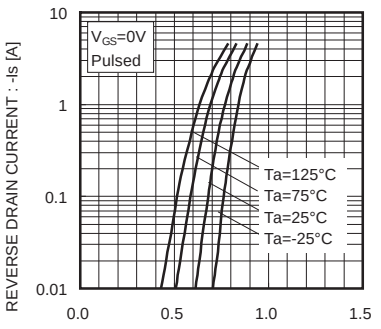



Fig.9 Reverse Drain Current vs. Sourse-Drain Voltage

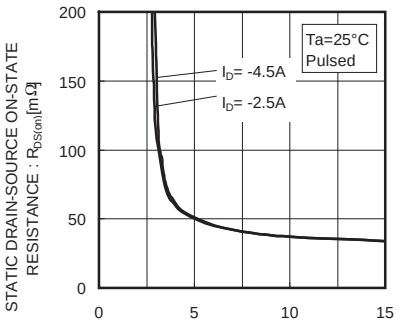



Fig.10 Static Drain-Source On-State Resistance vs. Gate Source Voltage

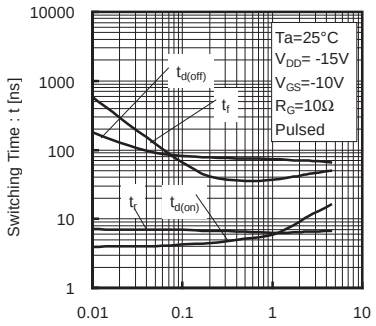



Fig.11 Switching Characteristics

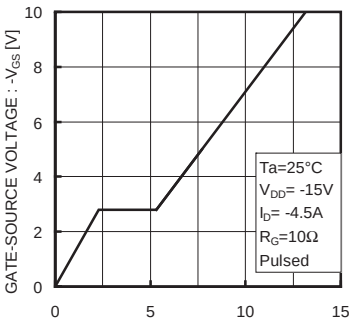



Fig.12 Dynamic Input Characteristics

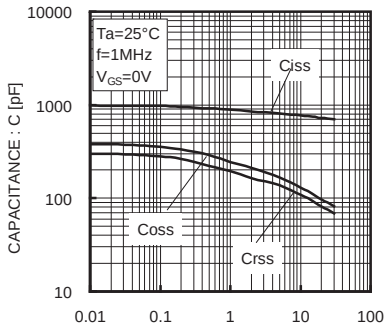



Fig.13 Typical Capacitance vs. Drain-Source Voltage

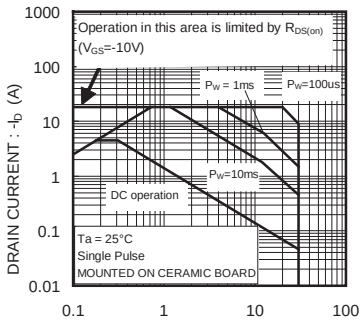



Fig.14 Maximum Safe Operating Area

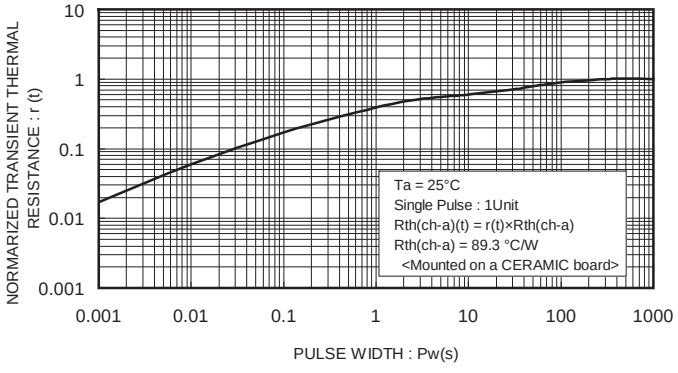



Fig.15 Normalized Transient Thermal Resistance vs. Pulse Width

## ●Measurement circuits

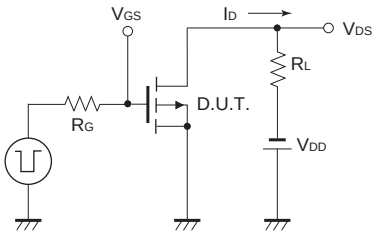



Fig.1-1 Switching Time Test Circuit

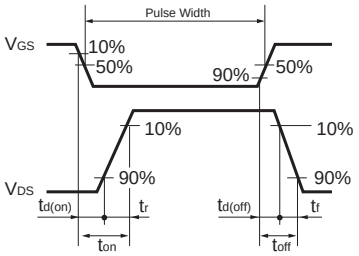



Fig.1-2 Switching Time Waveforms

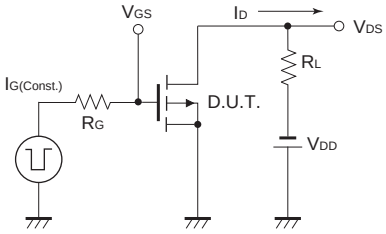



Fig.2-1 Gate Charge Test Circuit

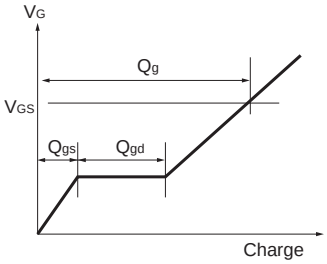



Fig.2-2 Gate Charge Waveform

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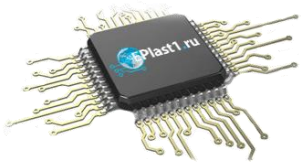


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